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1:3 Clock Buffer

General Description

The SLG3SY3952 uses a single input 26 MHz clock source to provide three 26 MHz clock outputs.

Features

- 1.8 V VDD operation
- Current Consumption: 1.0 mA
- OE for 26M_A, 26M_B and 26M_C
- Supports Industrial temperature range
- Improved performance over temperature
- · Smaller package and layout foot print
- 10-pin STDFN: 1.0 x 2.0 x 0.55 mm, 0.4 mm pitch
- Pb-Free / Halogen-Free / RoHS compliant

Pin Configuration



10-pin STDFN (Top View)

Output Summary

• 3x 26 MHz clock outputs

Block Diagram





Pin Description

Pin #	Pin Name	Type ¹	Pin Description
1	GND	GND	Ground
2	VDD	PWR	Power Supply: 1.8 V as main power supply. 1.0 μ F decoupling capacitor is recommended.
3	MODE_OUT	O, SE	Mode: 1.8 V CMOS output signal that identifies the mode SLG3SY3952 is in. May be used as clock request. PMOS Open Drain output. Requires 100 k Ω pull down resistor.
4	26M_IN	I	Clock Input: 26 MHz clock input.
5	OE_26M_C	I	Output Enable: Output enable for the 26M_C output as well as the control signal for the Power Mode switching.
6	26M_C	O, SE	Clock Output: 26 MHz output (Stop by OE_26M_C)
7	OE_26M_B	I	Output Enable: Output enable for the 26M_B output as well as the control signal for the Power Mode switching.
8	26M_B	O, SE	Clock Output: 26 MHz output (Stop by OE_26M_B)
9	26M_A	O, SE	Clock Output: 26 MHz output (Stop by OE_26M_A)
10	OE_26M_A	I	Output Enable: Output enable for the 26M_C output as well as the control signal for the Power Mode switching.
Notes: 1. Type Defini • PWR: po • GND: gr	itions ower ound		·

• I: input

O: output

SE: single ended signal

CMOS Input Specifications (OE¹)

 $T_A = 25 \ ^{\circ}C$ (unless otherwise stated)

Symbol	Description	Conditions	Min	Тур	Max	Unit	
V _{IH}	Input Voltage HIGH		1.5			V	
V _{IL}	Input Voltage LOW				0.3	V	
Notes: 1. V _{OE} < V _{DD} + 0.3 V must be met at all times including power up, where V _{OE} is the voltage on OE pin and V _{DD} is the voltage on VDD pin.							



26 MHz Clock Output Characteristics (26M)

 $T_A = 25 \text{ °C}, V_{DD} = 1.8 \text{ V}$ (unless otherwise stated)

Symbol	Description	Conditions	Min	Тур	Max	Unit
F _{INI}	Initial Frequency		5		50	MHz
DC	Duty Cycle	0.5 x V _{DD}	45	50	55	%
V _{OH}	Output Voltage HIGH	I _{OH} = 1 mA	0.8 x V _{DD}	2		V
V _{OL}	Output Voltage LOW	I _{OL} = -1 mA		2	0.2 x V _{DD}	V
t _{PU} ^{3,5}	Power Up Delay (t _{PU,MHz})	See Note 3 & 5		3	5	μS
t _{OE} ^{4,5}	Output Enable Delay (t _{OE,MHz})	See Note 4 & 5	0	1.0	2.0	μS
t _R	Rise Time	measured between $V_{OH,min}$ and $V_{OL,max}$		TBD		ns
t _F	Fall Time	measured between $V_{OH,min}$ and $V_{OL,max}$		TBD		ns
CL	Output Load Capacitance			8	10	pF

Notes:

1. This parameter tracks Reference Crystal characteristics.

2. V_{OH} = 1.0 x V_{DD} (typ) and V_{OL} = 0 V (typ) when driving a fully capacitive load, i.e. I_{OH} = I_{OL} = 0 mA.

3. This parameter is applicable when the device powers up into Active Mode (OE = VDD during power up) or transitions into Active Mode immediately after power up. The delay time is referenced from the point where V_{DD} ≥ V_{DD,min} is met to the 26 MHz output being stable and valid. If OE is left floating, t_{PU} may be longer.

4. This parameter is applicable when the device enters Active Mode from Hibernate Mode during normal operation. The delay time is referenced from the point where $OE \ge V_{IH,min}$ is met to the 26 MHz output being stable and valid.

5. Both t_{PU} and t_{OE} should be satisfied in order for the 26 MHz output to be stable and valid.



Power Supply Electrical Specifications (VDD)

T_A = 25 °C

Symbol	Description	Conditions	Min	Тур	Max	Unit
V _{DD} ¹	Operating Voltage for VDD		1.7	1.8	1.9	V
I_{VDD}^2	V _{DD} current consumption	V _{DD} = 1.8 V		1.0		mA

Notes:

1. $V_{OE} < V_{DD} + 0.3$ V must be met at all times including power up, where V_{OE} is the voltage on OE pin and V_{DD} is the voltage on VDD pin. 2. Average current depends on application and output load. Specified values are for No Load condition.



Timing Diagrams

Output Enable Delay (26 MHz Output)





Package Top Marking System Definition





Package Drawing and Dimensions



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Symbol	Min	Nom.	Max	Symbol	Min	Nom.	Max
A	0.50	0.55	0.60	D	1.95	2.00	2.05
A1	0.005	-	0.060	E	0.95	1.00	1.05
A2	0.10	0.15	0.20	L1	0.35	0.40	0.45
b	0.13	0.18	0.23	L2	0.175	0.225	0.275
е	0.40 BSC			S		0.2 REF	







Recommended Land Pattern (Top View)

Units: µm





Recommended Reflow Soldering Profile

Please see IPC/JEDEC J-STD-020: latest revision for reflow profile based on package volume of 1.10 mm³ (nominal). More information can be found at www.jedec.org.



Ordering Information

Part Number	Туре	Production Flow
SLG3SY3952V	10-pin STDFN	Industrial, -40 °C to 85 °C
SLG3SY3952VTR	10-pin STDFN (Tape and Reel)	Industrial, -40 °C to 85 °C



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